

FR150-83

Hakko WICK No Clean 1.5mm x 1.5m Desolder braid

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Economical and easy-to-use Desolder braid

Handy for the removal of solder after dismounting surface-mounted components including BGAs

Faster thermal transmission for superior performance at lower temperature and with lower wattage soldering irons.

Three different

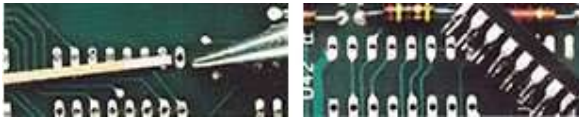
Regular type: Rosin flux treated copper braid

Unflux type: Untreated copper braid

No clean type: Low residue flux treated copper braid

Using ESD SAFE package

Removal for thru-hole...



Removal for bridging...



Usage/Applications

Desoldering wire is used to remove solder from an elemental device or from patterns on a printed circuit board (PCB) from which surface-mounted devices such as BGA (ball grid array) have been removed.